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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









Rev. V1

Designed primarily for wideband large–signal output and driver stages to $30-500\ \text{MHz}.$

N-Channel enhancement mode MOSFET

- Push–pull configuration reduces even numbered harmonics
- Guaranteed performance at 500 MHz, 28 Vdc

Output power = 40 W Gain = 14 dB

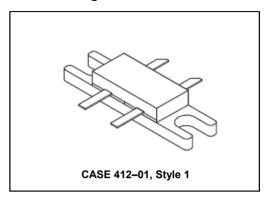
Efficiency = 50%

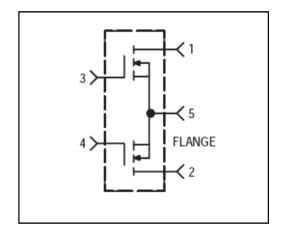
Typical performance at 175 MHz, 28 Vdc

Output power = 40 W Gain = 17 dB Efficiency = 60%

- Excellent thermal stability, ideally suited for Class A operation
- Facilitates manual gain control, ALC and modulation techniques
- 100% tested for load mismatch at all phase angles with 30:1 VSWR
- Low Crss 4.0 pF @ VDS = 28 V

Product Image





MAXIMUM RATINGS (T.j = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Drain-Gate Voltage	VDSS	65	Vdc
Drain-Gate Voltage (R _{GS} = 1.0 MΩ)	VDGR −	65	Vdc
Gate-Source Voltage	V _{GS}	± 20	Adc
Drain Current — Continuous	ΙD	8.0	ADC
Total Device Dissipation @ T _C = 25°C Derate above 25°C	PD	175 1.0	Watts °C/W
Storage Temperature Range	T _{stg}	-65 to +150	°C
Operating Junction Temperature	TJ	200	°C

THERMAL CHARACTERISTICS

Thermal Resistance — Junction to Case	R _{eJC}	1.0	°C/W

NOTE — <u>CAUTION</u> — MOS devices are susceptible to damage from electrostatic charge. Reasonable precautions in handling and packaging MOS devices should be observed.

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MRF166W



The RF MOSFET Line 40W, 500MHz, 28V

Rev. V1

ELECTRICAL CHARACTERISTICS (TC = 25°C unless otherwise noted)

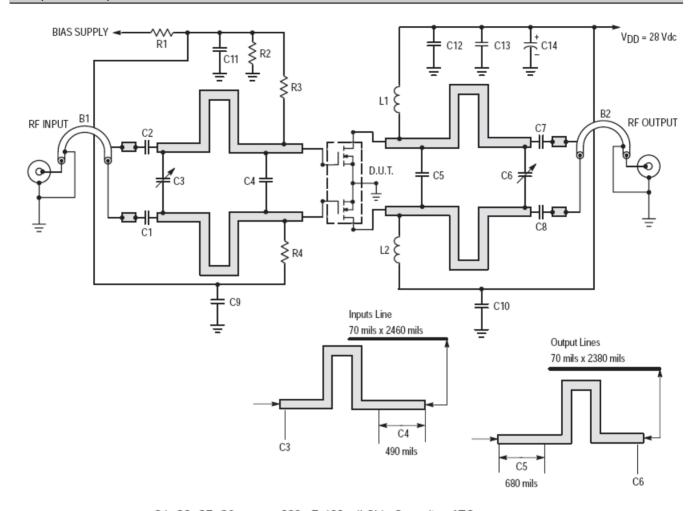
Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS (1)					
Drain–Source Breakdown Voltage (VGS = 0 Vdc, I _D = 5.0 mA)	V(BR)DSS	65	_	_	Vdc
Zero Gate Voltage Drain Current (V _{DS} = 28 Vdc, V _{GS} = 0 Vdc)	IDSS	_	_	0.5	mA
Gate-Source Leakage Current (VGS = 20 Vdc, VDS = 0 Vdc)	IGSS	_	_	1.0	μА
ON CHARACTERISTICS (1)					
Gate Threshold Voltage (VDS= 10 Vdc, ID = 25 mA)	V _{GS(th)}	1.5	3.0	4.5	Vdc
Forward Transconductance (VDS= 10 Vdc, ID = 1.5 A)	9fs	0.9	1.1	_	mS
DYNAMIC CHARACTERISTICS (1)					
Input Capacitance (VDS = 28 Vdc, VGS = 0 Vdc, f = 1.0 MHz)	Ciss	_	28	_	pF
Output Capacitance (VDS = 28 Vdc, VGS = 0 Vdc, f = 1.0 MHz)	Coss	_	30	_	pF
Reverse Transfer Capacitance (VDS = 28 Vdc, VGS = 0 Vdc, f = 1.0 MHz)	C _{rss}	_	4.0	_	pF
FUNCTIONAL CHARACTERISTICS (2)					
Common Source Power Gain (V _{DD} = 28 Vdc, P _{out} = 40 W, f = 500 MHz, I _{DQ} = 100 mA)	G _{ps}	14	16	_	dB
Drain Efficiency (V _{DD} = 28 Vdc, P _{out} = 40 W, f = 500 MHz, I _{DQ} = 100 mA)	η	50	55	_	%
Electrical Ruggedness (VDD = 28 Vdc, Pout = 40 W, f = 500 MHz, IDQ = 100 mA) Load VSWR = 30:1, All phase angles at frequency of test	Ψ	No Degradation in Output Power			er
Series Equivalent Input Impedance (V _{DD} = 28 Vdc, P _{out} = 40 W, f = 500 MHz, I _{DQ} = 100 mA)	Z _{in}	_	2.88 -j7.96	_	Ohms
Series Equivalent Output Impedance (V _{DD} = 28 Vdc, P _{out} = 40 W, f = 500 MHz, I _{DQ} = 100 mA)	Z _{out}	_	6.12 –j9.43	_	Ohms

⁽¹⁾ Each transistor chip measured separately.

⁽²⁾ Both transistor chips operating in a push-pull amplifier.



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C1, C2, C7, C8 220 pF, 100 mil Chip Capacitor, ATC C3, C6 0 - 10 pF, Johanson C4 27 pF, 100 mil Chip Capacitor, ATC C5 22 pF, 100 mil Chip Capacitor, ATC C9, C10, C11, C12 0.01 µF Blue Capacitor C13 470 pF, 100 mil Chip Capacitor, ATC C14 50 μF, 50 V Electrolytic Capacitor L1, L2 8 Turns #20 AWG, 0.100 mils ID B1, B2 6" long, ID = 550 mils, 50 Ω Semi-Rigid Coax R1 1.0 kΩ 1/2 Watt

R2 10 k Ω 1/2 Watt R3, R4 45 Ω 1/2 Watt Board Material – Teflon® Fiberglass

Dielectric Thickness = 0.30", $\epsilon_{\rm f}$ = 2.55 Copper Clad, 2.0 oz. Copper

Figure 1. MRF166W 500 MHz Test Circuit Schematic



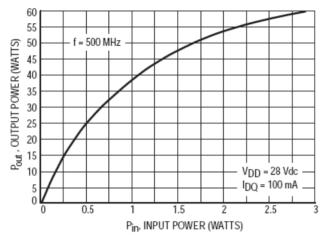


Figure 2. Output Power versus Input Power, 28 Vdc

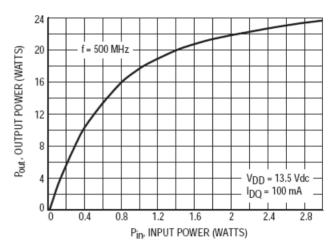


Figure 3. Output Power versus Input Power, 13.5 Vdc

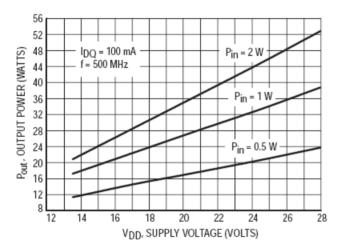


Figure 4. Output Power versus Supply Voltage

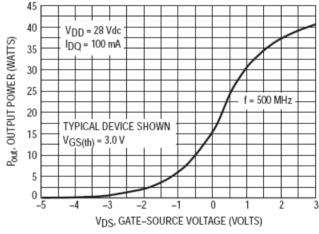


Figure 5. Output Power versus Gate Voltage



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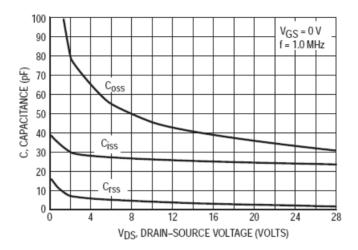
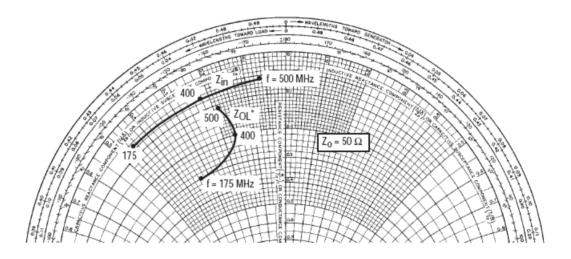


Figure 6. Capacitance versus Voltage



 V_{DD} = 28 Vdc, I_{DQ} = 100 mA, P_{out} = 40 W

f MHz	Z _{in} Ohms	Z _{OL} * Ohms
175	3.7 – j 22.4	15.2 – j 16.6
400	3.6 - j 10.99	10.3 – j 7.99
500	2.88 – j 7.96	6.12 – j 9.43

Table 1. Input and Output Impedances

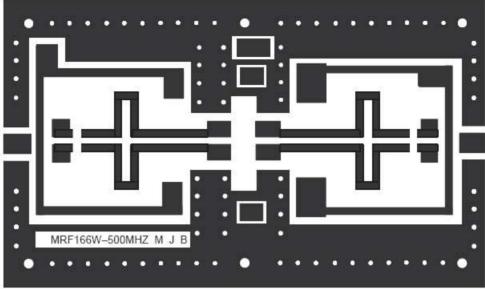
Z_{OL}* = Conjugate of the optimum load impedance into which the device output operates at a given output power, voltage and frequency.

NOTE: Input and output impedance values given are measured from gate to gate and drain to drain respectively.

Figure 7. Series Equivalent Input/Output Impedance



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NOTES: 1) 3 X 5 inch Glass Teflon® 32 Mil Board, Copper Both Sides

(Scale 1:1)

- 2) Small Holes are 40 Mils ID and Plated Through
- 3) Large Holes are 140 Mils ID and Plated Through

Figure 8. MRF166W Circuit Board Photomaster

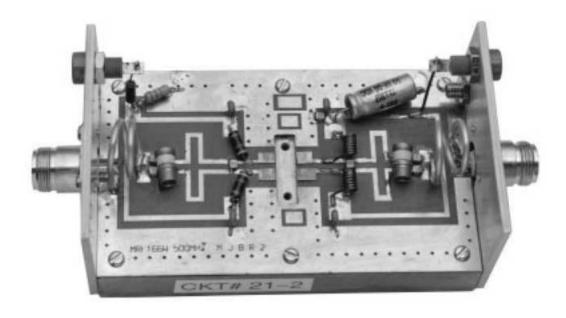


Figure 9. MRF166W Test Fixture



Table 1. Common Source S-Parameters (VDS = 24 V, ID = 230 mA)

,		S ₁₁		21	(V _{DS} = 24 V,	12	s ₂₂		
f MHz	S ₁₁	ф	S ₂₁	ф	S ₁₂	ф	S ₂₂	ф	
30	0.554	-85	20.30	128	0.044	28	0.628	-121	
40	0.775	-113	20.00	113	0.040	26	0.632	-123	
50	0.758	-124	17.50	107	0.041	20	0.652	-135	
60	0.711	-132	14.60	100	0.050	20	0.570	-135	
70	0.751	-139	12.70	100	0.042	11	0.666	-145	
80	0.742	-143	11.30	95	0.043	9	0.666	-149	
90	0.724	-146	10.00	92	0.042	8	0.657	-151	
100	0.730	-149	8.97	90	0.042	6	0.663	-154	
110	0.735	-151	8.29	87	0.043	3	0.683	-156	
120	0.732	-153	7.53	84	0.042	2	0.666	-158	
130	0.734	-155	7.01	83	0.042	1	0.688	-159	
140	0.740	-156	6.57	81	0.043	0	0.701	-160	
150	0.747	-157	6.01	78	0.042	-2	0.688	-162	
160	0.748	-159	5.66	76	0.041	-4	0.715	-162	
170	0.741	-160	5.22	76	0.040	-4	0.690	-161	
180	0.746	-160	4.94	74	0.041	-4	0.719	-164	
190	0.753	-161	4.67	73	0.041	-6	0.725	-165	
200	0.756	-162	4.51	70	0.040	-7	0.729	-166	
210	0.755	-162	4.15	69	0.039	-8	0.727	-165	
220	0.759	-163	3.91	68	0.039	-8	0.724	-166	
230	0.767	-163	3.75	65	0.039	-10	0.751	-169	
240	0.769	-164	3.56	64	0.038	-12	0.733	-167	
250	0.766	-164	3.41	63	0.037	-12	0.726	-167	
260	0.767	-165	3.26	63	0.035	-10	0.725	-167	
270	0.773	-165	3.07	61	0.035	-10	0.725	-167	
280	0.777	-165	3.03	61	0.035	-11	0.753	-167	
290	0.777	-166	2.89	58	0.034	-13	0.732	-169	
300	0.782	-166	2.80	57	0.034	-11	0.744	-169	
310	0.788	-166	2.66	57	0.034	-12	0.764	-169	
320	0.794	-167	2.54	55	0.033	-12	0.760	-167	
330	0.796	-167	2.47	54	0.032	-13	0.787	-169	
340	0.795	-168	2.38	54	0.031	-13	0.753	-170	
350	0.799	-168	2.27	52	0.030	-11	0.772	-168	
360	0.804	-168	2.17	51	0.030	-11	0.782	-169	
370	0.805	-168	2.15	50	0.030	-11	0.796	-169	
380	0.807	-169	2.06	48	0.029	-12	0.782	-170	
390	0.812	-169	2.00	48	0.028	-12	0.796	-170	
400	0.818	-170	1.91	47	0.027	-10	0.784	-168	
410	0.821	-170	1.86	46	0.029	-11	0.830	-170	
420	0.821	-170	1.83	44	0.028	-11	0.823	-171	
430	0.822	-171	1.74	44	0.026	-9	0.791	-170	
440	0.826	-171	1.67	43	0.025	-7	0.788	-170	



Table 1. Common Source S-Parameters (VDS = 24 V, ID = 230 mA) (continued)

f	S.	s ₁₁		s ₂₁		s ₁₂		22
MHz	S ₁₁	ф	\$ ₂₁	ф	S ₁₂	ф	\$ ₂₂	ф
450	0.830	-171	1.68	42	0.025	-7	0.820	-170
460	0.831	-172	1.64	41	0.026	-10	0.843	-174
470	0.832	-172	1.54	41	0.025	-7	0.827	-173
480	0.835	-173	1.50	39	0.024	-3	0.836	-172
490	0.835	-173	1.43	38	0.024	1	0.835	-171
500	0.823	-174	1.43	37	0.025	3	0.849	-172
600	0.874	-176	1.12	29	0.003	-171	0.873	-176
700	0.910	-179	0.86	23	0.013	89	0.867	-177
800	0.932	179	0.74	18	0.035	61	0.904	178
900	0.966	176	0.63	12	0.029	68	0.897	179
1000	0.975	172	0.54	5	0.042	49	0.953	174



Table 2. Common Source S-Parameters (VDS = 28 V, ID = 250 mA)

f	S ₁₁ S ₂₁		21	S-	12	S	22	
MHz	S ₁₁	ф	\$ ₂₁	ф	S ₁₂	ф	S ₂₂	ф
30	0.601	-86	22.20	128	0.040	29	0.796	-119
40	0.783	-112	21.20	114	0.037	27	0.616	-122
50	0.764	-122	18.50	108	0.038	21	0.637	-133
60	0.727	-131	15.50	101	0.045	21	0.574	-135
70	0.759	-138	13.50	100	0.039	12	0.648	-143
80	0.751	-142	12.10	95	0.040	9	0.649	-148
90	0.732	-146	10.70	93	0.040	8	0.641	-150
100	0.737	-149	9.55	90	0.040	6	0.648	-153
110	0.741	-150	8.81	88	0.040	4	0.670	-155
120	0.738	-153	8.01	85	0.040	3	0.654	-156
130	0.740	-154	7.47	83	0.040	2	0.675	-157
140	0.747	-156	7.01	82	0.040	1	0.684	-158
150	0.754	-157	6.43	79	0.040	-2	0.669	-161
160	0.757	-159	6.07	77	0.039	-3	0.693	-161
170	0.749	-159	5.59	76	0.038	-3	0.670	-161
180	0.753	-160	5.28	75	0.039	-4	0.701	-163
190	0.759	-161	4.99	73	0.039	-5	0.712	-164
200	0.761	-161	4.81	70	0.038	-7	0.719	-165
210	0.759	-162	4.44	70	0.037	-6	0.713	-163
220	0.762	-163	4.18	69	0.037	-7	0.709	-164
230	0.771	-164	4.03	66	0.037	-9	0.733	-167
240	0.775	-164	3.83	65	0.036	-10	0.715	-165
250	0.774	-165	3.69	64	0.035	-10	0.713	-166
260	0.775	-165	3.52	63	0.034	-10	0.715	-168
270	0.780	-165	3.29	61	0.034	-10	0.712	-168
280	0.782	-165	3.24	61	0.034	-11	0.741	-168
290	0.781	-166	3.10	59	0.032	-12	0.722	-168
300	0.785	-166	3.01	58	0.033	-11	0.733	-168



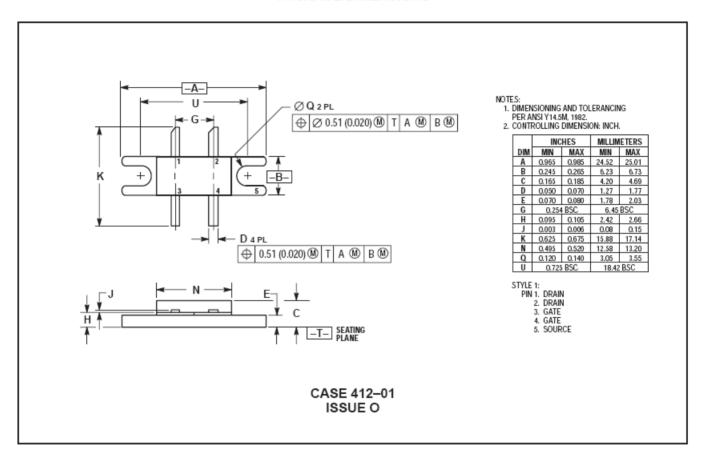
Table 2. Common Source S-Parameters (VDS = 28 V, ID = 250 mA) (continued)

f	f \$11		s ₂₁		s	s ₁₂		s ₂₂	
MHz	S ₁₁	ф	\$ ₂₁	ф	S ₁₂	ф	\$ ₂₂	φ	
310	0.792	-167	2.87	57	0.032	-12	0.750	-167	
320	0.798	-167	2.75	56	0.032	-12	0.739	-166	
330	0.801	-168	2.68	53	0.031	-13	0.760	-170	
340	0.800	-168	2.58	53	0.030	-14	0.727	-172	
350	0.803	-169	2.44	52	0.029	-12	0.755	-170	
360	0.807	-169	2.33	50	0.029	-12	0.772	-171	
370	0.808	-169	2.30	50	0.029	-12	0.787	-169	
380	0.809	-169	2.19	48	0.028	-13	0.768	-170	
390	0.813	-170	2.14	49	0.027	-13	0.775	-169	
400	0.820	-170	2.06	47	0.026	-11	0.765	-167	
410	0.823	-170	2.02	45	0.027	-12	0.805	-170	
420	0.823	-171	1.98	44	0.026	-13	0.794	-173	
430	0.824	-171	1.89	44	0.025	-12	0.778	-174	
440	0.828	-172	1.83	43	0.024	-11	0.785	-173	
450	0.832	-172	1.81	41	0.024	-10	0.812	-172	
460	0.833	-172	1.75	41	0.025	-13	0.838	-175	
470	0.835	-172	1.65	41	0.023	-11	0.817	-173	
480	0.840	-172	1.60	40	0.022	-10	0.818	-172	
490	0.844	-173	1.55	38	0.022	-10	0.819	-172	
500	0.845	-173	1.56	37	0.022	-10	0.833	-173	
600	0.879	-176	1.21	29	0.002	138	0.870	-176	
700	0.912	-179	0.92	23	0.017	77	0.862	-176	
800	0.935	179	0.79	18	0.039	58	0.887	179	
900	0.966	176	0.67	11	0.030	69	0.892	179	
1000	0.974	172	0.57	5	0.043	49	0.945	175	



Rev. V1

PACKAGE DIMENSIONS



MRF166W



The RF MOSFET Line 40W, 500MHz, 28V

Rev. V1

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